

Sensors and Materials

Special Issue on Smart Sensing Technologies and Their Application in Forest Management and Engineering

Call for Papers

Forests provide a vital role in our lives by providing oxygen production, timber products, and spaces for outdoor recreation, and many living creatures such as plants, animals, and insects inhabit diverse forest ecosystems. Thus, it is essential to monitor and protect forests and their resources. In recent years, smart sensing technologies for monitoring forest resources and assessing environmental impacts associated with forest utilization have been rapidly developing in the fields of forest management and engineering. The purpose of this Special Issue is to highlight the significance and contribution of smart sensing technologies in forest management and engineering. It will focus on theoretical and experimental studies including individual or integrated devices and machinery, sensors, and technologies that enable the more efficient management and protection of forest resources.

Scope:

- Forest resources monitoring and assessment
- Forest disaster monitoring and mapping
- Urban forest monitoring
- Environmental impacts associated with forest utilization

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